# 16-BIT, 4-MSPS, PSEUDO-BIPOLAR, FULLY DIFFERENTIAL INPUT, MICROPOWER SAMPLING ANALOG-TO-DIGITAL CONVERTER WITH PARALLEL INTERFACE, REFERENCE 

## FEATURES

- Fully Differential Input with Pseudo-Bipolar Input Range -4 V to +4 V
- 16-Bit NMC at 4 MSPS
- 1 LSB INL Typ
- 92dB SNR, -102dB THD Typ with 100-kHz Input
- Internal 4.096-V Reference and Reference Buffer
- REFIN/2 Available for Setting Analog Input Common-Mode Voltage
- Zero Latency
- High-Speed Parallel Interface
- Single Supply Operation Capability
- Low Power: 155 mW at 4 MHz Typ, Flexible Power-Down Scheme
- Pin-Out Similar to ADS8412/8402
- 48-Pin $9 \times 9$ TQFP Package


## APPLICATIONS

## - DWDM

- Instrumentation
- High-Speed, High-Resolution, Zero Latency Data Acquisition Systems
- Transducer Interface
- Medical Instruments
- Spectrum Analysis
- ATE


## DESCRIPTION

The ADS8422 is a $16-$ bit, $4-\mathrm{MHz} \mathrm{A/D} \mathrm{converter} \mathrm{with}$ an internal 4.096-V reference. The device includes a 16-bit capacitor-based multi-bit SAR A/D converter with inherent sample and hold. This converter includes a full 16-bit interface and an 8-bit option where data is read using two 8-bit read cycles if necessary.
The ADS8422 has a fully differential, pseudo-bipolar input. It is available in a 48-lead TQFP package and is characterized over the industrial $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ temperature range.

HIGH-SPEED SAR CONVERTER FAMILY ${ }^{(1)}$

| TYPE/SPEED | 500 kHz | $\sim 600 \mathrm{kHz}$ | 750 kHz | 1 MHz | 1.25 MHz | 2 MHz | 3 MHz | 4MHz |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 18-Bit Pseudo-Diff | ADS8383 | ADS8381 |  | ADS8481 |  |  |  |  |
|  |  | ADS8380 (s) |  |  |  |  |  |  |
| 18-Bit Pseudo-Bipolar, Fully Diff |  | ADS8382 (s) |  | ADS8482 |  |  |  |  |
| 16-Bit Pseudo-Diff |  | ADS8370 (s) | ADS8371 | ADS8471 | ADS8401 | ADS8411 |  |  |
|  | ADS8327/28 (s) | ADS8372 (s) |  | ADS8329/30 (s) | ADS8405 | ADS8410 (s) |  |  |
| 16-Bit Pseudo-Bipolar, Fully Diff |  |  |  | ADS8472 | ADS8402 | ADS8412 |  | ADS8422 |
|  |  |  |  |  | ADS8406 | ADS8413 (s) |  |  |
| 14-Bit Pseudo-Diff |  |  |  |  | ADS7890 (s) |  | ADS7891 |  |
| 12-Bit Pseudo-Diff |  |  |  | ADS7886 |  | ADS7883 |  | ADS7881 |

(1) S : Serial


These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## ORDERING INFORMATION ${ }^{(1)}$

| MODEL | MAXIMUM INTEGRAL LINEARITY (LSB) | MAXIMUM DIFFERENTIAL LINEARITY (LSB) | NO MISSING CODES RESOLUTION (BIT) | PACKAGE TYPE | PACKAGE DESIGNATOR | TEMPERATURE RANGE | ORDERING INFORMATION | TRANSPORT MEDIA QTY. |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS8422I | $\pm 6$ | $\pm 2$ | 15 | $\begin{aligned} & 9 \times 9 \text { 48-Pin } \\ & \text { TQFP } \end{aligned}$ | PFB | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | ADS8422IPFBT | Small tape and reel 250 |
|  |  |  |  |  |  |  | ADS8422IPFBR | Tape and reel 1000 |
| ADS8422IB | $\pm 2$ | +1.5/-1 | 16 | $\begin{aligned} & 9 \times 9 \text { 48-Pin } \\ & \text { TQFP } \end{aligned}$ | PFB | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | ADS8422IBPFBT | Small tape and reel 250 |
|  |  |  |  |  |  |  | ADS8422IBPFBR | Tape and reel 1000 |

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com

## ABSOLUTE MAXIMUM RATINGS ${ }^{(1)}$

over operating free-air temperature range (unless otherwise noted)

|  |  | VALUE | UNIT |
| :---: | :---: | :---: | :---: |
|  | +IN to AGND | -0.4 to +VA + 0.1 | V |
|  | -IN to AGND | -0.4 to +VA + 0.1 | V |
| Voltage | +VA to AGND | -0.3 to 7 | V |
|  | +VBD to BDGND | -0.3 to 7 | V |
| Digital input voltage to BDGND |  | -0.3 to +VBD +0.3 | V |
| Digital output voltage to BDGN |  | -0.3 to +VBD +0.3 | V |
| $\mathrm{T}_{\mathrm{A}} \quad$ Operating free-air temperature | ange | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ Storage temperature range |  | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |
| Junction temperature ( $\mathrm{T}_{\mathrm{J}} \mathrm{max}$ ) |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| TQFP 48-pin package | Power dissipation | $\left(T_{J} M a x-T_{A}\right) / \theta_{J A}$ |  |
| TQFP 48-pin package | $\theta_{\mathrm{JA}}$ thermal impedance | 86 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Lead temperature | Vapor phase (60 sec) | 215 | ${ }^{\circ} \mathrm{C}$ |
| Lead temperature, soldering | Infrared (15 sec) | 220 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

ADS8422
INSTRUMENTS
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## SPECIFICATIONS

$\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C},+\mathrm{VA}=5 \mathrm{~V}$, $+\mathrm{VAREG}=5 \mathrm{~V}$ to $3 \mathrm{~V},+\mathrm{VBD}=5 \mathrm{~V}$ to $2.7 \mathrm{~V}, \mathrm{f}_{\text {SAMPLE }}=4 \mathrm{MSPS}, \mathrm{V}_{\text {ref }}=4.096 \mathrm{~V}$ (measured with internal reference buffer) (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG INPUT |  |  |  |  |  |  |
| Full-scale input voltage ${ }^{(1)}$ |  | $+\mathrm{IN}-(-\mathrm{IN})$ | $-\mathrm{V}_{\text {ref }}$ |  | $\mathrm{V}_{\text {ref }}$ | V |
| Absolute input voltage |  | $+\mathrm{IN}$ | -0.2 |  | $\mathrm{V}_{\text {ref }}+0.2$ | V |
|  |  | -IN | -0.2 |  | $\mathrm{V}_{\text {ref }}+0.2$ |  |
| Common-mode input range |  |  | $\left(\mathrm{V}_{\text {ref }}\right) / 2-0.2$ | $\left(\mathrm{V}_{\text {ref }}\right) / 2$ | $\left(\mathrm{V}_{\text {ref }}\right) / 2+0.2$ | V |
| Input capacitance |  |  |  | 30 |  | pF |
| Input leakage current |  |  |  |  | 1 | nA |
| SYSTEM PERFORMANCE |  |  |  |  |  |  |
| Resolution |  |  |  | 16 |  | Bits |
| No missing codes | ADS84221 |  | 15 |  |  | Bits |
|  | ADS8422IB |  | 16 |  |  |  |
| Integral linearity ${ }^{(2)(3)}$ | ADS84221 |  | -6 | $\pm 2$ | 6 | $\begin{gathered} \text { LSB } \\ (16 \mathrm{bit})^{(2)} \end{gathered}$ |
|  | ADS8422IB |  | -2 | $\pm 1$ | 2 |  |
| Differential linearity | ADS8422I |  | -2 | $\pm 0.7$ | 2 | $\begin{gathered} \text { LSB } \\ \text { (16 bit) } \end{gathered}$ |
|  | ADS8422IB |  | -1 | $\pm 0.7$ | 1.5 |  |
| Offset error |  |  | -0.5 | $\pm 0.25$ | 0.5 | mV |
| Offset error drift |  |  |  | $\pm 0.2$ |  | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| Gain error ${ }^{(4)(5)}$ |  | $\mathrm{V}_{\text {ref }}=4.096 \mathrm{~V}$ | -0.1 | $\pm 0.05$ | 0.1 | \%FS |
| Gain error drift |  | $\mathrm{V}_{\text {ref }}=4.096 \mathrm{~V}$ | $\pm 2$ |  |  | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| Common-mode rejection ratio |  | At dc |  | 81 |  | dB |
|  |  | At code 0000h with $[+\mathrm{IN}+(-\mathrm{IN})] / 2=$ $512 \mathrm{mV}_{\mathrm{pp}}$ at 500 kHz , |  | 78 |  |  |
| Noise |  | At 0000h output code |  | 40 |  | $\mu \mathrm{V}$ RMS |
| Power supply rejection ratio |  | At 8000h output code |  | 78 |  | dB |
| SAMPLING DYNAMICS |  |  |  |  |  |  |
| Conversion time |  |  |  |  | 0.180 | $\mu \mathrm{s}$ |
| Acquisition time |  |  | 0.070 |  |  | $\mu \mathrm{s}$ |
| Throughput rate |  |  |  |  | 4 | MHz |
| Aperture delay |  |  |  | 3 |  | ns |
| Aperture jitter |  |  |  | 7 |  | ps RMS |
| Step response |  |  |  | 70 |  | ns |
| Overvoltage recovery |  |  |  | 140 |  | ns |

(1) Ideal input span, does not include gain or offset error.
(2) LSB means least significant bit and is equal to $2 \mathrm{~V}_{\text {REF }} / 65536$.
(3) This is endpoint INL, not best fit.
(4) Measured relative to an ideal full-scale input $[+I N-(-I N)]$ of 8.192 V .
(5) This specification does not include the internal reference voltage error and drift.

## SLAS512B-JUNE 2006-REVISED DECEMBER 2006

## SPECIFICATIONS (Continued)

$\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C},+\mathrm{VA}=5 \mathrm{~V}$, $+\mathrm{VAREG}=5.25 \mathrm{~V}$ to $3 \mathrm{~V},+\mathrm{VBD}=5 \mathrm{~V}$ to $2.7 \mathrm{~V}, \mathrm{f}_{\text {SAMPLE }}=4 \mathrm{MSPS}, \mathrm{V}_{\text {ref }}=4.096 \mathrm{~V}$ (measured with internal reference buffer) (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC CHARACTERISTICS |  |  |  |  |  |  |
| Total harmonic distortion (THD) ${ }^{(1)}$ | $\mathrm{V}_{\mathrm{IN}}=8 \mathrm{~V}_{\mathrm{pp}}$ | 10 kHz |  | -114 |  | dB |
|  |  | 100 kHz |  | -102 |  |  |
|  |  | 500 kHz |  | -100 |  |  |
| Signal to noise ratio (SNR) | $\mathrm{V}_{\mathrm{IN}}=8 \mathrm{~V}_{\mathrm{pp}}$ | 10 kHz |  | 93 |  | dB |
|  |  | 100 kHz |  | 92 |  |  |
|  |  | 500 kHz |  | 90 |  |  |
| Signal to noise + distortion (SINAD) | $\mathrm{V}_{\mathrm{IN}}=8 \mathrm{~V}_{\mathrm{pp}}$ | 10 kHz |  | 92.5 |  | dB |
|  |  | 100 kHz |  | 91.5 |  |  |
|  |  | 500 kHz |  | 89.5 |  |  |
| Spurious free dynamic range (SFDR) | $\mathrm{V}_{\mathrm{IN}}=8 \mathrm{~V}_{\mathrm{pp}}$ | 10 kHz |  | 116 |  | dB |
|  |  | 100 kHz |  | 109 |  |  |
|  |  | 500 kHz |  | 106 |  |  |
| -3dB Small signal bandwidth |  |  |  | 30 |  | MHz |
| Maximum input frequency, $\mathrm{f}_{\mathrm{i}(\text { max })}{ }^{(2)}$ | $\mathrm{V}_{\mathrm{IN}}=8 \mathrm{~V}_{\mathrm{pp}}$ |  | 2 |  |  | MHz |
| VOLTAGE REFERENCE INPUT |  |  |  |  |  |  |
| Reference voltage at REFIN, $\mathrm{V}_{\text {ref }}$ |  |  | 3.9 | 4.096 | 4.15 | V |
| Reference resistance |  |  |  | 1000 |  | $\mathrm{M} \Omega$ |
| INTERNAL REFERENCE OUTPUT |  |  |  |  |  |  |
| Internal reference start-up time | From $95 \%$ (+VA), with 1- $\mu \mathrm{F}$ capacitor on REFOUT |  |  |  | 25 | ms |
| Reference voltage range, $\mathrm{V}_{\text {ref }}$ | $\mathrm{I}_{\mathrm{O}}=0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 4.088 | 4.096 | 4.104 | V |
| Source current | Static load |  |  |  | 10 | $\mu \mathrm{A}$ |
| Line regulation | $+\mathrm{VA}=4.75 \mathrm{~V}$ to 5.25 V |  | $\pm 1$ |  |  | mV |
| Drift | $\mathrm{I}_{\mathrm{O}}=0$ |  | $\pm 6$ |  |  | PPM $/{ }^{\circ} \mathrm{C}$ |
| ANALOG COMMON-MODE, PIN 3 |  |  |  |  |  |  |
| Output voltage range | $\mathrm{l} \mathrm{O}^{\prime}=0$ |  | $\mathrm{V}_{\text {REF }} / 2-0.016$ | $\mathrm{V}_{\text {REF }} / 2$ | $\mathrm{V}_{\text {REF }} / 2+0.016$ | V |
| Source current | Static load |  | 200 |  |  | $\mu \mathrm{A}$ |

(1) Calculated on the first nine harmonics of the input frequency.
(2) ADC Sampling circuit is optimized to accept inputs until Nyquist frequency. Dynamic performance may degrade rapidly above $f_{i(\max )}$.

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## SPECIFICATIONS (Continued)

$\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C},+\mathrm{VA}=5 \mathrm{~V}$, $+\mathrm{VAREG}=5 \mathrm{~V}$ to $3 \mathrm{~V},+\mathrm{VBD}=5 \mathrm{~V}$ to $2.7 \mathrm{~V}, \mathrm{f}_{\text {SAMPLE }}=4 \mathrm{MSPS}, \mathrm{V}_{\text {ref }}=4.096 \mathrm{~V}$ (measured with internal reference buffer) (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIGITAL INPUT/OUTPUT |  |  |  |  |  |  |
| Logic family - CMOS |  |  |  |  |  |  |
| Logic level | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{I}_{\mathrm{IH}}=5 \mu \mathrm{~A}$ | $0.75 \times$ (+VBD) |  | +VBD + 0.3 | V |
|  | $\mathrm{V}_{\text {IL }}$ | $\mathrm{I}_{\mathrm{LL}}=5 \mu \mathrm{~A}$ | -0.3 |  | 0.8 |  |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{I}_{\mathrm{OH}}=2$ TTL loads | +VBD - 0.6 |  |  |  |
|  | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{I}_{\mathrm{LL}}=2$ TTL loads |  |  | 0.4 |  |
| Data format - Twos complement |  |  |  |  |  |  |
| POWER SUPPLY REQUIREMENTS |  |  |  |  |  |  |
| Power supply voltage | +VA |  | 4.75 | 5 | 5.25 | V |
|  | +VAREG |  | 2.85 | 3.0 | 5.25 |  |
|  | +VBD |  | 2.7 | 3.0 | 5.25 |  |
| Supply current | +VA | $+\mathrm{VA}=5 \mathrm{~V}, \overline{\mathrm{PD1}}=1, \overline{\mathrm{PD} 2}=1$ |  | 24 | 27 | mA |
|  | +VAREG | +VAREG $=5 \mathrm{~V}, \overline{\text { PD1 }}=1, \overline{\text { PD2 }}=1$ |  | 12 | 14 | mA |
|  |  | +VAREG $=3 \mathrm{~V}, \mathrm{PD1}=1$, PD2 $=1$ |  | 12 | 14 |  |
|  | +VBD ${ }^{(1)}$ | +VBD $=3 \mathrm{~V}, 10 \mathrm{pF} / \mathrm{pin}$ |  | 0.55 |  | mA |
|  |  | +VBD $=5 \mathrm{~V}, 20 \mathrm{pF} / \mathrm{pin}$ |  | 1.8 |  |  |
| POWER DOWN ${ }^{(2)}$ |  |  |  |  |  |  |
| Supply current | +VA | $\overline{\mathrm{PD1}}=0, \overline{\mathrm{PD} 2}=1,+\mathrm{VA}=5 \mathrm{~V}$ |  | 2.5 | 3.4 | mA |
|  | +VAREG |  |  | 5 |  | $\mu \mathrm{A}$ |
| Power |  |  |  |  | 17 | mW |
| Power-up time |  | (PD1, PD2) : 0,1$) \rightarrow(1,1)$ |  |  | 5 | $\mu \mathrm{s}$ |
| Supply current | +VA | $\mathrm{PD1}=0, \mathrm{PD2}=0$ |  | 5 |  | $\mu \mathrm{A}$ |
|  | +VAREG |  |  | 5 |  |  |
| Power |  |  |  | 40 |  | $\mu \mathrm{W}$ |
| Power-up time |  | (PD1, PD2) : $(0,0) \rightarrow(1,1), 1-\mu \mathrm{F}$ Storage capacitor from REFOUT to AGND |  |  | 25 | ms |
| TEMPERATURE RANGE |  |  |  |  |  |  |
| Operating free-air |  |  | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |

(1) This includes the current required for charging the external load capacitance on the digital outputs and is measured with four digital outputs toggling at the same time.
(2) $\left(\mathrm{PD}_{1}, \overline{\mathrm{PD}}_{2}\right)=(1,0)$ is reserved. Do not use this power-down pins combination.

## TIMING CHARACTERISTICS FROM DIGITAL INPUTS

All specifications typical at $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C},+\mathrm{VBD}=2.7 \mathrm{~V}$ to $5.25 \mathrm{~V}{ }^{(1)(2)}$

| PARAMETER |  |  | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CONVERSION AND ACQUISITION |  |  |  |  |  |  |
| $\mathrm{t}_{(A C Q)}$ | Acquisition time, internal to device, not externally visible |  | 70 |  |  | ns |
|  | Pulse duration, CONVST low |  | 20 |  |  | ns |
| $\mathrm{t}_{\mathrm{w} 2}$ | Pulse duration, CONVST high |  | 100 |  |  | ns |
| $\mathrm{t}_{\mathrm{p} 1}$ | Period, CONVST |  | 250 |  |  | ns |
| $\mathrm{t}_{\mathrm{q} 1}$ | Quiet time, last toggle of interface input signals during acquisition before CONVST falling ${ }^{(3)}$ |  | 30 |  |  | ns |
| $\mathrm{t}_{\mathrm{q} 2}$ | Quiet time, CONVST falling to first toggle of interface input signals ${ }^{(3)}$ |  | 10 |  |  | ns |
| POWER DOWN |  |  |  |  |  |  |
|  | Pulse duration | PD1 low for only ADC reset (no powerdown) | 20 |  | 500 | ns |
|  |  | PD1 low for ADC reset and also ADC powerdown | 1500 |  |  |  |
|  |  | $\overline{\text { PD2 }}$ low pulse duration for REFOUT and COMMOUT buffers powerdown | 1500 |  |  |  |
| Pulse duration, all others unspecified |  |  | 10 |  |  | ns |

(1) All input signals are specified with $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=5 \mathrm{~ns}\left(10 \%\right.$ to $90 \%$ of $\left.\mathrm{V}_{\mathrm{DD}}\right)$ and timed from after $90 \%$ of transition
(2) All digital output signals loaded with $10-\mathrm{pF}$ capacitors at $+\mathrm{VBD}=2.7 \mathrm{~V}$ and $20-\mathrm{pF}$ capacitor at $+\mathrm{VBD}=5.25 \mathrm{~V}$ and timed to reaching $90 \%$ of transition.
(3) Quiet time zones are for meeting performance and not functionality.

## TIMING CHARACTERISTICS OF DIGITAL OUTPUTS

All specifications typical at $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C},+\mathrm{VBD}=2.7 \mathrm{~V}$ to $5.25 \mathrm{~V}{ }^{(1)(2)}$

| PARAMETER |  | MIN | TYP MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| CONVERSION AND ACQUISITION |  |  |  |  |
| $\mathrm{t}_{\text {(CONV) }}$ | Conversion time, internal to device, not externally visible |  | 180 | ns |
| $\mathrm{t}_{\mathrm{d} 1}$ | Delay time, CONVST fall to conversion start (aperture delay) |  | 3 | ns |
| DATA READ OPERATION |  |  |  |  |
| $\mathrm{t}_{\mathrm{d} 2}$ | Delay time, $\overline{\text { CONVST }}$ low to data valid if $\overline{\mathrm{CS}}=\overline{\mathrm{RD}}=0$ |  | 225 | ns |
| $\mathrm{t}_{\mathrm{d} 3}$ | Delay time, data valid to BUSY low if $\overline{\mathrm{CS}}=\overline{\mathrm{RD}}=0$ | 5 |  | ns |
| $\mathrm{t}_{\mathrm{d} 4}$ | Delay time, $\overline{\mathrm{RD}}$ (or $\overline{\mathrm{CS}}$ ) low to data valid |  | 17 | ns |
| $\mathrm{t}_{\mathrm{d} 5}$ | Delay time, BYTE toggle to data valid |  | 20 | ns |
| $\mathrm{t}_{\mathrm{d} 6}$ | Delay time, data three-state after $\overline{\mathrm{RD}}$ (or $\overline{\mathrm{CS}}$ ) high |  | 12 | ns |
| POWER DOWN |  |  |  |  |
| $\mathrm{t}_{\mathrm{d} 7}$ | Delay time, $\overline{\text { PD1 }}$ low to BUSY rising |  | 20 | ns |
| $\mathrm{t}_{\mathrm{d} 8}$ | Delay time, PD1 high to device operational (with PD2 held high) |  | 5 | $\mu \mathrm{s}$ |
|  | Delay time, PD2 high to REFOUT/COMMOUT valid |  | 25 | ms |
|  | Delay time, power up (after $\mathrm{AV}_{\mathrm{DD}}=4.75 \mathrm{~V}$ ) |  | 25 | ms |
| $\mathrm{t}_{\mathrm{d} 9}$ | Delay time, data three-state after PD1 low |  | 1.5 | $\mu \mathrm{s}$ |

(1) All input signals are specified with $t_{r}=t_{f}=5 \mathrm{~ns}\left(10 \%\right.$ to $90 \%$ of $\left.V_{D D}\right)$ and timed from after $90 \%$ of transition.
(2) All digital output signals loaded with $10-\mathrm{pF}$ capacitors at $+\mathrm{VBD}=2.7 \mathrm{~V}$ and $20-\mathrm{pF}$ capacitor at $+\mathrm{VBD}=5.25 \mathrm{~V}$ and timed to reaching $90 \%$ of transition.

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## PIN ASSIGNMENTS

## PFB Package

 (Top View)
A. NC - No connection
B. Pins 9 and 13 are internally regulated $3-\mathrm{V}$ outputs and are externally to be connected to decoupling capacitors only.
C. +VAREG can be connected to a $3-\mathrm{V}$ to $5-\mathrm{V}$ supply.
D. Pin 3 outputs REFIN/2
E. Pin 38 can be used for ADC powerdown and pin 37 for analog output powerdown.

## TERMINAL FUNCTIONS

| NAME | NO | I/O |  |  | DESCRIPTION |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AGND | $\begin{gathered} 5,8,12,14, \\ 15,44,45 \end{gathered}$ | - | Analog ground |  |  |
| BDGND | 25, 35 | - | Digital ground for bus interface digital supply |  |  |
| BUSY | 36 | 0 | Status output. High when a conversion is in progress. |  |  |
| BYTE | 39 | 1 | Byte select input. Used for 8-bit bus reading. <br> 0: No fold back <br> 1: Low byte $\mathrm{D}[7: 0$ ] of the 16 most significant bits is folded back to high byte of the 16 most significant pins $\mathrm{DB}[15: 8]$. |  |  |
| COMMOUT | 3 | O | This pin outputs REFIN/2 and can be used to set the common-mode voltage of the differential analog input, (+IN + $-\operatorname{IN}) / 2$. |  |  |
| CONVST | 40 | I | Convert start. This input is low true and can act independent of the $\overline{\mathrm{CS}}$ input. |  |  |
| $\overline{\text { CS }}$ | 42 | I | Chip select. |  |  |
| CAP1, CAP2 | 9, 13 | 0 | Decoupling of internally generated $3-\mathrm{V}$ supply. Add $1-\mu \mathrm{F}$ capacitor from these pins to AGND. |  |  |
| Data Bus |  |  | 8-BIT BUS |  | 16-BIT BUS |
|  |  |  | BYTE $=0$ | BYTE $=1$ | BYTE $=0$ |
| DB15 | 16 | 0 | D15 (MSB) | D7 | D15 (MSB) |
| DB14 | 17 | 0 | D14 | D6 | D14 |
| DB13 | 18 | 0 | D13 | D5 | D13 |
| DB12 | 19 | 0 | D12 | D4 | D12 |
| DB11 | 20 | O | D11 | D3 | D11 |
| DB10 | 21 | O | D10 | D2 | D10 |

TERMINAL FUNCTIONS (continued)


TYPICAL CHARACTERISTICS

HISTOGRAM OF 262144 CONVERSIONS OF DC INPUT AT CENTER CODE (Internal Reference)


Figure 1.

HISTOGRAM OF 262144
CONVERSIONS OF DC INPUT AT CENTER CODE (External Reference)


Figure 2.

INTERNAL REFERENCE VOLTAGE
FREE-AIR TEMPERATURE
(Three Devices Shown)


Figure 3.

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TYPICAL CHARACTERISTICS (continued)

## OFFSET VOLTAGE vs FREE-AIR TEMPERATURE



Figure 4.


Figure 7.


Figure 10.


Figure 5.
EFFECTIVE NUMBER OF BITS INPUT FREQUENCY


Figure 8.
SPURIOUS FREE DYNAMIC RANGE INPUT FREQUENCY


Figure 11.

SIGNAL-TO-NOISE RATIO INPUT FREQUENCY


Figure 6.
SIGNAL-TO-NOISE RATIO
VS
FREE-AIR TEMPERATURE


Figure 9.
TOTAL HARMONIC DISTORTION vs
FREE-AIR TEMPERATURE


Figure 12.

## TYPICAL CHARACTERISTICS (continued)



Figure 13.


Figure 16.


Figure 14.
INTEGRAL NONLINEARITY
FREE-AIR TEMPERATURE


Figure 17.
+VA CURRENT THROUGHPUT


Figure 15.
COMMON-MODE REJECTION RATIO FREQUSENCY


Figure 18.

DNL


Figure 19.

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TYPICAL CHARACTERISTICS (continued)


Figure 20.

FFT (10 kHz)


Figure 21.
FFT (100 kHz)


Figure 22.

TYPICAL CHARACTERISTICS (continued)


Figure 23.

## TIMING DIAGRAMS



Note: The DB shown here is internal to the device and output on the pins only if and when $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are both low (after $\mathrm{t}_{\mathrm{d} 4} \mathrm{~ns}$ ). This is shown in Figure 25 .

Figure 24. Conversion Control Timing


Note: Data is output on the pins only if $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are both low, $\mathrm{t}_{\mathrm{d} 4} \mathrm{~ns}$ after this condition is satisfied.
Figure 25. Data Read Timing


Note: Data is valid from the first conversion initiated $5 \mu$ s after $\overline{\text { PD1 }}$ is pulled high.
Figure 26. ADC Power-Down Timing


Note: Analog outputs are valid 25 ms after $\overline{\mathrm{PD} 2}$ is pulled high.
Figure 27. Analog Output Power-Down Timing

## RESET TIMING



Note: Data valid from first conversion initiated 100 ns after $\overline{\text { PD1 }}$ is pulled high.
Figure 28. ADC Reset

## PRINCIPLES OF OPERATION

The ADS8422 is a member of a family of high-speed multi-bit successive approximation register (SAR) analog-to-digital converters (ADC). The architecture is based on charge redistribution, which inherently includes a sample/hold function. See Figure 34 for the application circuit for the ADS8422.

The conversion clock is generated internally. The conversion time is a maximum of 180 ns that is capable of sustaining a $4-\mathrm{MHz}$ throughput.
The analog input is provided to two input pins: +IN and -IN . When a conversion is initiated, the differential input on these pins is sampled on the internal capacitor array. While a conversion is in progress, both inputs are disconnected from any internal function.

## REFERENCE

The ADS8422 has a built-in 4.096-V reference but can operate with an external 4.096-V reference. When internal reference is used, pin 2 (REFOUT) should be connected to pin 1 (REFIN) with a $0.1-\mu F$ decoupling capacitor and a $1-\mu \mathrm{F}$ storage capacitor between pin 2 (REFOUT) and pins 47 and 48 (REFM). The internal reference of the converter is double buffered. If an external reference is used, the second buffer provides isolation between the external reference and the CDAC. This buffer is also used to recharge all of the capacitors of the CDAC during conversion. Pin 2 (REFOUT) can be left unconnected (floating) if an external reference is used.

## ANALOG INPUT

The ADS8422 has a pseudo-bipolar, fully differential input. When the input is differential, the amplitude of the input equals the difference between +IN and -IN . The peak-to-peak amplitude of each input is $\mathrm{V}_{\text {REF }}$. However since the two inputs are $180^{\circ}$ out of phase, the peak-to-peak amplitude of the difference voltage $[+I N-(-I N)]$ is equal to $2 \mathrm{~V}_{\mathrm{REF}}$. The common-mode input range is from $\mathrm{V}_{\mathrm{REF}} / 2-0.2 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{REF}} / 2+0.2 \mathrm{~V}$.
In order to avoid additional external circuitry on the board, the ADS8422 outputs reference input on REFIN divided by 2 on pin 3 (COMMOUT). This voltage can be used to set the common-mode of the output from the input driver.

Figure 29, Figure 30, Figure 31, Figure 32, and Figure 33 show the recommended circuits to interface an analog input signal to the ADS8422.

PRINCIPLES OF OPERATION (continued)

A. Input common-mode voltage (Vincm) range is restricted by the amplifier. Refer to the amplifier data sheet for more information. Output common mode of the THS4131 is set by the voltage at pin 2. The COMMOUT pin of the ADS8422 is designed to source pin 2 of the THS4131. However to use this feature both the positive supply and negative supply rails must equal ( $|-\mathrm{VCC}|=|+\mathrm{VCC}|$ ), absolutely.

Figure 29. Fully Differential Input Driver Circuit for Unipolar or Bipolar Signals

## PRINCIPLES OF OPERATION (continued)


A. Input common-mode voltage (Vincm) range is restricted by the amplifier. Refer to the amplifier data sheet for more information. Output common mode of the THS4131 is set by the voltage at pin 2. The COMMOUT pin of the ADS8422 is designed to source pin 2 of the THS4131. However to use this feature both the positive supply and negative supply rails must equal $(|-\mathrm{VCC}|=|+\mathrm{VCC}|)$, absolutely.

Figure 30. Single-Ended Input Driving Circuit for When Input is Unipolar or Bipolar

PRINCIPLES OF OPERATION (continued)


Figure 31. Single-Ended Driving Circuit for When Input is Single-Ended Unipolar and has Common-Mode of 2.048 V


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## PRINCIPLES OF OPERATION (continued)



Figure 33. Driver Circuit for Bipolar Fully Differential Input Signals with 0-V Common-Mode
The input current on the analog inputs depends upon a number of factors: sample rate, input voltage, and source impedance. Essentially, the current into the ADS8422 charges the internal capacitor array during the sample period. After this capacitance has been fully charged, there is no further input current. The source of the analog input voltage must be able to charge the input capacitance ( 30 pF ) to a 16 -bit settling level within the 70 ns acquisition time of the device. When the converter goes into hold mode, the input impedance is greater than 1 G $\Omega$.

Care must be taken regarding the absolute analog input voltage. To maintain the linearity of the converter, both $-I N$ and $+\mathbb{N}$ inputs should be within the limits specified. Outside of these ranges, the converter linearity may not meet specifications. To minimize noise, low bandwidth input signals with low pass filters should be used.
Care should be taken to ensure that the output impedances of the sources driving the +IN and -IN inputs are matched. If this is not observed, the two inputs could have different setting times. This may result in offset error, gain error, and linearity error which change with temperature and input voltage.
When the converter enters hold mode, the voltage difference between the $+\mathbb{N}$ and $-\mathbb{N}$ inputs is captured on the internal capacitor array.

## DIGITAL INTERFACE

## Timing and Control

See the timing diagrams for detailed information on timing signals and their requirements.
The ADS8422 uses an internal oscillator generated clock which controls the conversion rate and in turn the throughput of the converter. No external clock input is required.

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## PRINCIPLES OF OPERATION (continued)

Conversions are initiated by bringing the CONVST pin low for a minimum of 20 ns (after the 20 ns minimum requirement has been met, the CONVST pin can be brought high). The converter switches from sample to hold mode on the falling edge of the CONVST command. A clean and low jitter falling edge of this signal is important to the performance of the converter. The BUSY pin is brought high immediately following CONVST going low. BUSY stays high through the conversion process and returns low when the conversion has ended and data is available on the DB pins. Once the conversion is started, it cannot be stopped except with an asynchronous RESET (or a logical PD1).
If CONVST is detected high at the end of conversion, the device immediately enters sampling mode and the analog input is connected to the CDAC. Otherwise, the CDAC is connected to the analog input only when CONVST goes high. The high duration of CONVST should be at least 100 ns . There is no maximum high pulse duration specification for CONVST.

## Reading Data

The ADS8422 outputs full parallel data in 2's complement format as shown in Table 1. The parallel output is active when $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are both low. There is a minimal quiet zone requirement around the falling edge of CONVST. This is 30 ns prior to the falling edge of CONVST and 10 ns after the falling edge. No data read should be attempted within this zone. Any other combination of $\overline{C S}$ and $\overline{\mathrm{RD}}$ three-states the parallel output. BYTE is used for multi-word read operation. BYTE is used whenever lower bits on the bus are output on the higher byte of the bus. Refer to Table 1 for ideal output codes.

Table 1. Ideal Input Voltages and Output Codes

| DESCRIPTION | ANALOG VALUE | DIGITAL OUTPUT 2'S COMPLIMENT |  |
| :--- | :---: | :---: | :---: |
| Full scale range | $2 \mathrm{~V}_{\text {ref }}$ |  |  |
| Least significant bit (LSB) | $2 \mathrm{~V}_{\text {ref }} / 65536$ | BINARY CODE | HEX CODE |
| +Full scale | $\left(+\mathrm{V}_{\text {ref }}\right)-$ | 0111111111111111 | 7 FFF |
| Midscale | 0 V | 0000000000000000 | 0000 |
| Midscale -1 LSB | $0 \mathrm{~V}-$ | 1111111111111111 | FFFF |
| -Full scale | $-\mathrm{V}_{\text {ref }^{+}}$ | 1000000000000000 | 8000 |

The output data can be read as a full 16 -bit word on pins DB15 - DB0 (MSB-LSB) if BYTE is low.
The result may also be read on an 8 -bit bus for convenience. This is done by using only pins DB15-DB8. In this case two reads are necessary: the first as before, leaving BYTE low and reading the 8 most significant bits on pins DB15-DB8, then bringing BYTE high. When BYTE is high, the low bits (D7-D0) appear on pins DB15-DB8.
These multi-word read operations can be performed with a multiple active (toggling) $\overline{\mathrm{RD}}$ signal or with the $\overline{\mathrm{RD}}$ signal tied low for simplicity.

Table 2. Conversion Data Read Out

| BYTE | DATA READ OUT |  |
| :---: | :---: | :---: |
|  | PINS <br> DB15-DB8 | PINS <br> DB7-DB0 |
| High | D7-D0 | All One's |
| Low | D15 - D8 | D7-D0 |

## RESET

$\overline{\text { RESET } / P D 1}$ is an asynchronous active low input signal. Maximum $\overline{\text { RESET/PD1 }}$ low time is $0.5 \mu$ s to avoid ADC powerdown. Current conversion is aborted no later than 20 ns after the converter is in reset mode. The converter returns to normal operation mode no later than 20 ns after the RESET/PD1 input is brought high (see Figure 28).
The converter provides two power saving options: ADC powerdown (using pin 38, $\overline{\mathrm{PD} 1}$ ) and analog output powerdown (ㄹD2).

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ADC powerdown is activated by asserting $\overline{\mathrm{PD1}}$ to 0 for longer than $1.5 \mu \mathrm{~s}$. If the signal $\overline{\mathrm{PD1}}$ is asserted 0 for less than $0.5 \mu \mathrm{~s}$, the ADC is only reset and any ongoing conversion aborted. See Figure 26. ADC operation can be resumed from ADC powerdown by de-asserting the PD1 pin. In ADC power-down mode, the analog outputs from the ADC(COMMOUT, REFOUT) are not powered down thereby reducing the power-on time.
Full chip power-down is activated by turning off the power supply or by asserting both, $\overline{\mathrm{PD} 1}=0$ and $\overline{\mathrm{PD2}}=0$ for longer than $1.5 \mu \mathrm{~s}$ (see Figure 27). In this mode, even the analog outputs of the ADC (COMMOUT, REFOUT) are powered down thereby giving maximum power saving. Device operation can be resumed from full chip power-down by turning on the power supply or by deasserting both, $\overline{\mathrm{PD} 1}=1$ and $\overline{\mathrm{PD} 2}=1$.

Table 3. Effects of RESET, $\overline{\text { PD1 }}$, and $\overline{\text { PD2 }}$

| COMMAND | APPLICATION TIME | POWER WHEN APPLIED | RESUME TIME |
| :---: | :---: | :---: | :---: |
| RESET/PD1 $=0$ | 20 ns | No change | 20 ns |
| $\overline{\mathrm{PD} 1}=0, \overline{\mathrm{PD} 2}=1$ | $1.5 \mu \mathrm{~s}$ | 17 mW | $5 \mu \mathrm{~s}$ |
| $\overline{\mathrm{PD} 1}=\overline{\mathrm{PD} 2}=0$ | $1.5 \mu \mathrm{~s}$ | $40 \mu \mathrm{~W}$ | 25 ms |
| $\overline{\mathrm{PD} 1}=1, \overline{\mathrm{PD} 2}=0$ | Reserved - Do not use this combination |  |  |

## LAYOUT

For optimum performance, care should be taken with the physical layout of the ADS8422 circuitry.
As the ADS8422 offers single-supply operation, it is often used in close proximity with digital logic, microcontrollers, microprocessors, and digital signal processors. The more digital logic present in the design and the higher the switching speed, the more difficult it is to achieve good performance from the converter.
The basic SAR architecture is sensitive to glitches or sudden changes on the power supply, reference, ground connections, and digital inputs that occur just prior to latching the output of the analog comparator. Thus, driving any single conversion for an n-clock SAR converter, there are n windows in which large external transient voltages can affect the conversion result. Such glitches might originate from switching power supplies, nearby digital logic, or high power devices. The 50 ns period before BUSY falls should be kept free of supply glitches.

The degree of error in the digital output depends on the reference voltage, layout, and the exact timing of the external event.
On average, the ADS8422 draws very little current from an external reference as the reference voltage is internally buffered. If the reference voltage is external and originates from an op amp, make sure that it can drive the bypass capacitor or capacitors without oscillation. A $0.1-\mu \mathrm{F}$ bypass capacitor is recommended from pin 1 directly to REFM (pin 48). REFM and AGND should be shorted on the same ground plane underneath the device.
The AGND, BDGND, and AGND pins should be connected to a clean ground point. In all cases, this should be the analog ground. Avoid connections which are too close to the grounding point of a microcontroller or digital signal processor. If required, run a ground trace directly from the converter to the power supply entry point. The ideal layout consists of an analog ground plane dedicated to the converter and associated analog circuitry.
As with the AGND connections, +VA and +VAREG should be connected to their respective power supply planes or traces that are separate from the connection for digital logic, until they are connected at the power entry point. Power to the ADS8422 should be clean and well bypassed. A $0.1-\mu \mathrm{F}$ ceramic bypass capacitor should be placed as close to the device as possible. See table 4 for capacitor placement. In addition, a $1-\mu \mathrm{F}$ to $10-\mu \mathrm{F}$ capacitor is recommended. In some situations, additional bypassing may be required, such as a $100-\mu \mathrm{F}$ electrolytic capacitor or even a Pi filter made up of inductors and capacitors - all designed to essentially low-pass filter the $+5-\mathrm{V}$ supply, thus removing the high frequency noise.

Table 4. Power Supply Decoupling Capacitor Placement

| POWER SUPPLY PLANE | CONVERTER ANALOG SIDE | CONVERTER <br> DIGITAL SIDE |
| :---: | :---: | :---: |
| SUPPLY PINS |  | $(24,25),(34,35)$ |
| Pin pairs that require shortest path to decoupling capacitors | $(4,5),(9),(10,12),(13,15),(43,44),(46,45)$ | $(2)$ |

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## APPLICATION INFORMATION

## ADS8422 TO A HIGH PERFORMANCE DSP INTERFACE

Figure 34 shows a parallel interface between the ADS8422 and a Texas instruments high performance DSP such as the TMS320C6713 using the full 16-bit bus. The ADS8422 is mapped onto the CE2 memory space of the TMS320C6713 DSP. The read and reset signals are generated by using a 3 -to- 8 decoder. A read operation from the address 0xA000C000 generates a pulse on the RD pin of the data converter, wheras a read operation form word address 0xA0014000 generates a pulse on the RESET/PD1 pin. The CE2 signal of the DSP acts as $\overline{C S}$ (chip select) for the converter. As the TMS320C6713 features a 32 -bit external memory interface, the BYTE input of the converter can be tied permanently low, disabling the foldback of the data bus. The BUSY signal of the ADS8422 is appiled to the EXT_INT6 interrupt input of the DSP, enabling the EDMA controller to react on the falling edge of this signal and to collect the conversion result. The TOUT1 (timer out 1) pin of the TMS320C6713 is used to source the CONVST signal of the converter.

A. This resistor $(0 \Omega)$ can be installed to use the same $5-\mathrm{V}$ supply.

Figure 34. ADS8422 Application Circuitry

A. This resistor $(0 \Omega)$ can be installed to use the same $5-\mathrm{V}$ supply.

Figure 35. ADS8422 Using Internal Reference

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## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead finish/ Ball material (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS8422IBPFBR | ACTIVE | TQFP | PFB | 48 | 1000 | RoHS \& Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | ADS <br> 8422\| <br> B | Samples |
| ADS8422IBPFBT | ACTIVE | TQFP | PFB | 48 | 250 | RoHS \& Green | Call TI | Level-2-260C-1 YEAR | -40 to 85 | $\begin{aligned} & \text { ADS } \\ & 84221 \\ & \text { B } \end{aligned}$ | Samples |
| ADS8422IBPFBTG4 | ACTIVE | TQFP | PFB | 48 | 250 | RoHS \& Green | Call TI | Level-2-260C-1 YEAR | -40 to 85 | $\begin{aligned} & \text { ADS } \\ & 84221 \\ & \text { B } \end{aligned}$ | Samples |
| ADS8422IPFBR | ACTIVE | TQFP | PFB | 48 | 1000 | RoHS \& Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | $\begin{aligned} & \text { ADS } \\ & 84221 \end{aligned}$ | Samples |
| ADS8422IPFBRG4 | ACTIVE | TQFP | PFB | 48 | 1000 | RoHS \& Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | $\begin{aligned} & \text { ADS } \\ & 84221 \end{aligned}$ | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
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NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
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${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS-026

PFB (S-PQFP-G48)


NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC-7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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